

[Fig. 34]

ELECTRIC FIELD SHIELDING CHARACTERISTIC (KEC METHOD) DUE
TO IMPROVEMENT OF CONDUCTIVITY

[Fig. 35]

MAGNETIC FIELD SHIELDING CHARACTERISTIC (KEC METHOD) DUE
TO IMPROVEMENT OF CONDUCTIVITY

[Fig. 36]

SHIELDING PERFORMANCE DUE TO IMPROVEMENT OF CONDUCTIVITY
(dB)

FREQUENCY (GHz)

[Fig. 37]

SHIELDING PERFORMANCE DUE TO IMPROVEMENT OF CONDUCTIVITY
(dB)

FREQUENCY (GHz)

[Fig. 38]

RETURN LOSS DUE TO IMPROVEMENT OF ELECTROMAGNETIC
ABSORPTION BY MOLECULAR VIBRATION (dB)

FREQUENCY (GHz)

[Fig. 39]

RETURN LOSS DUE TO IMPROVEMENT OF ELECTROMAGNETIC
ABSORPTION BY MOLECULAR VIBRATION (dB)

FREQUENCY (GHz)

FIG. 1

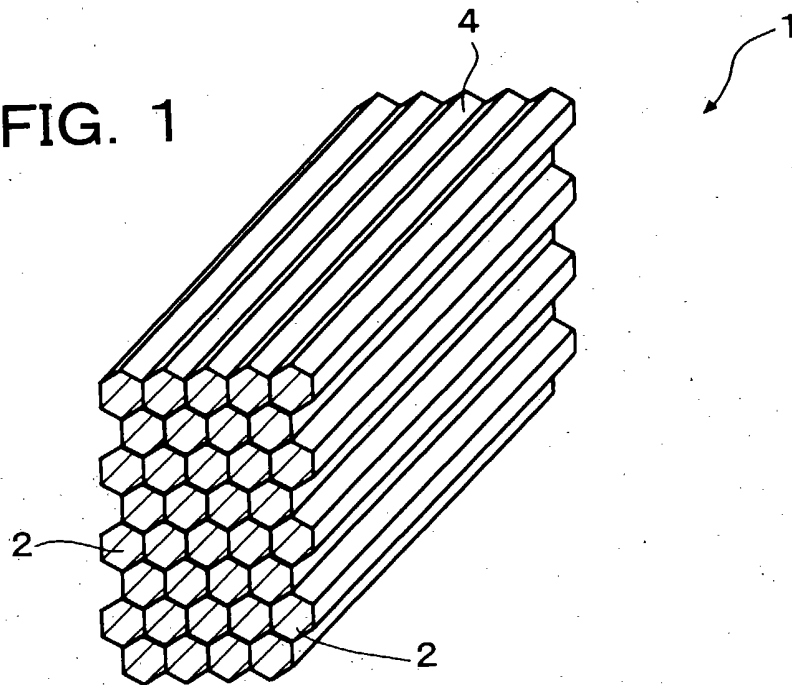


FIG. 2

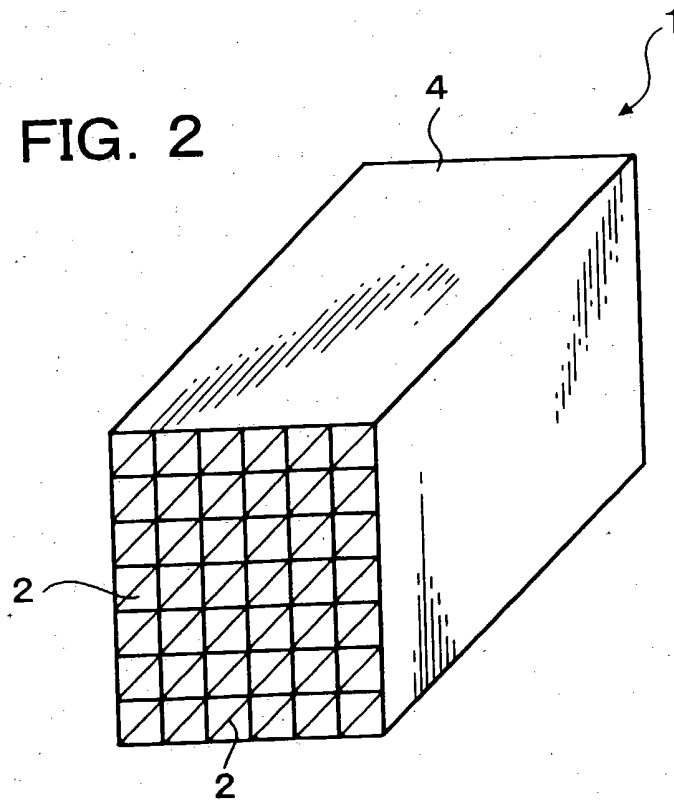


FIG. 3

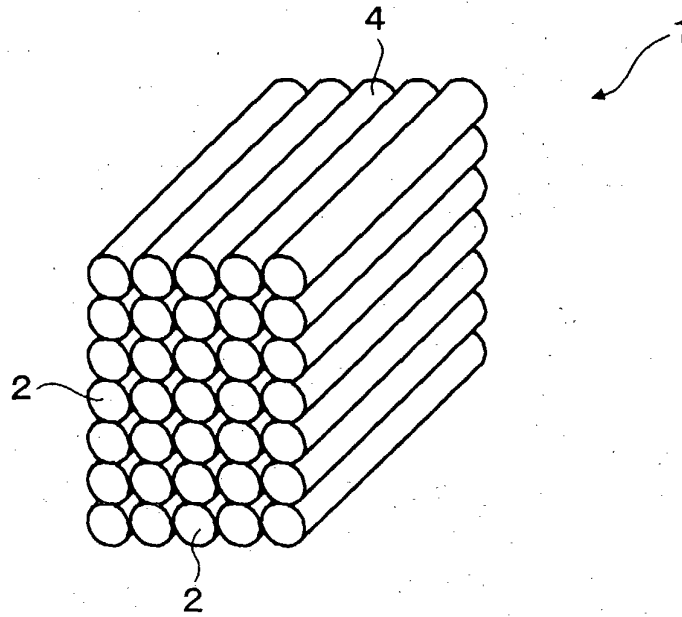


FIG. 4

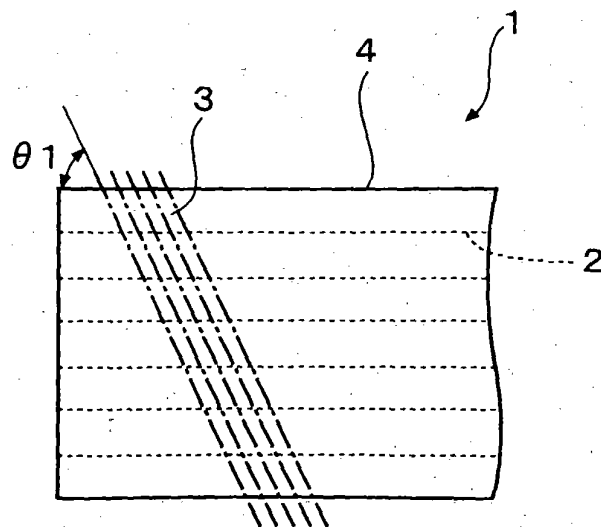


FIG. 5

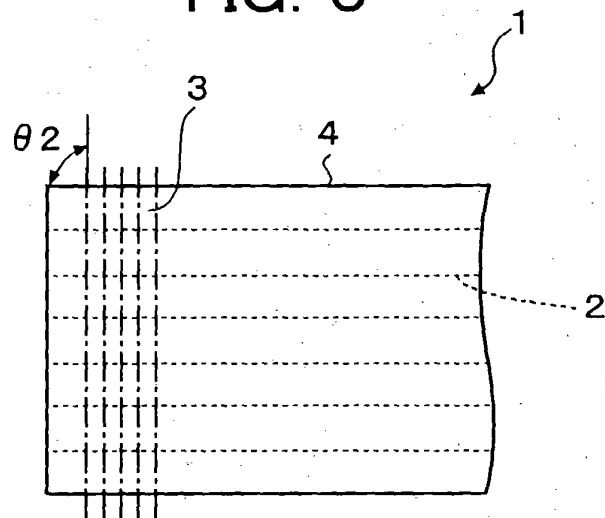


FIG. 6

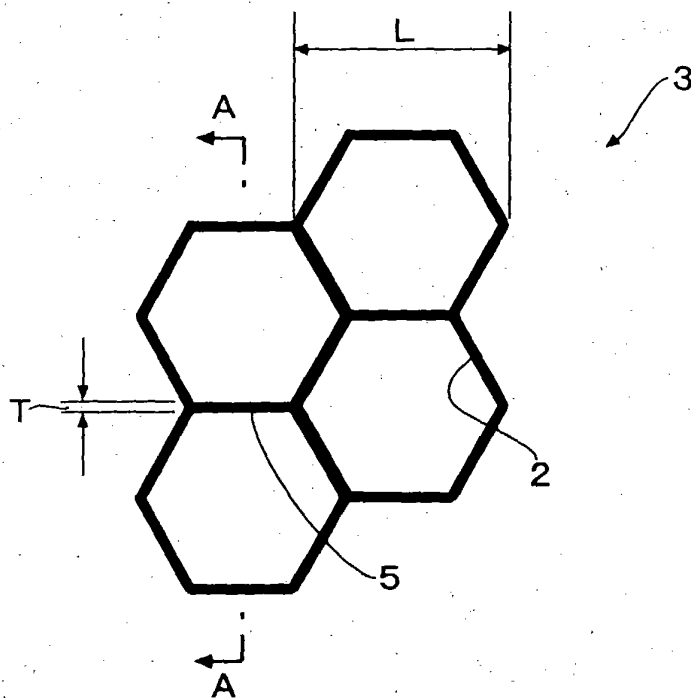


FIG. 7

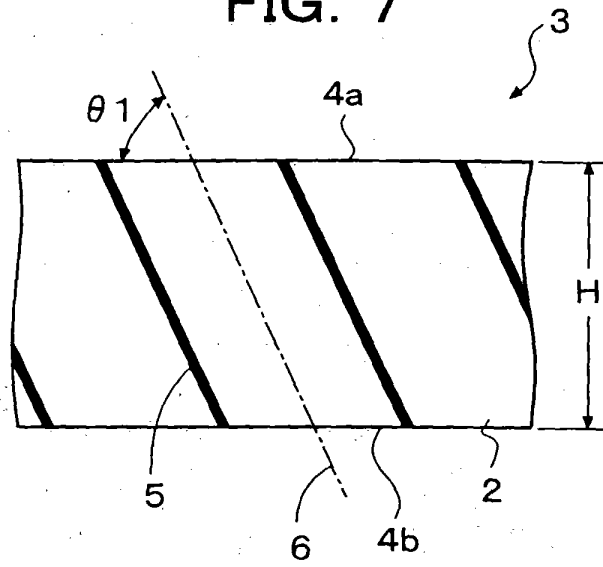


FIG. 8

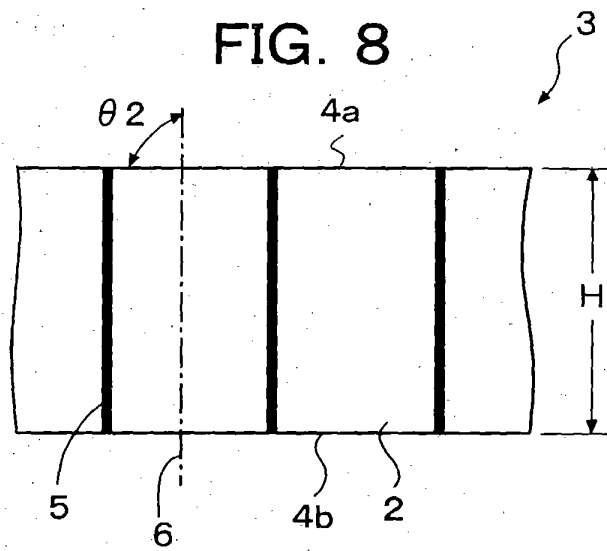


FIG. 9

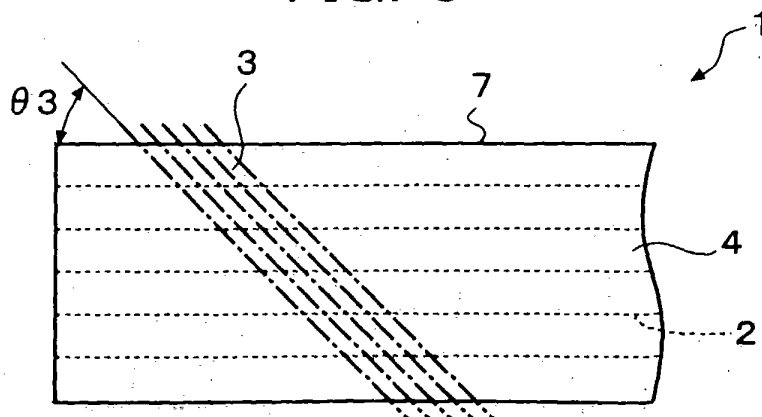


FIG. 10

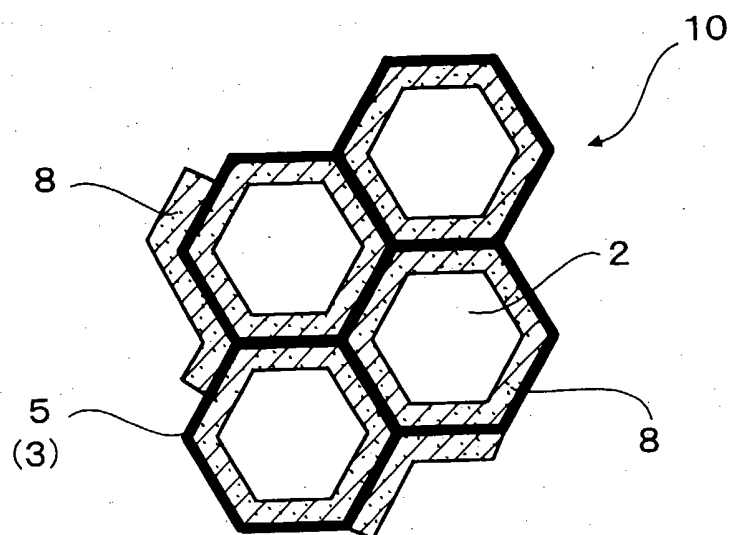


FIG. 11

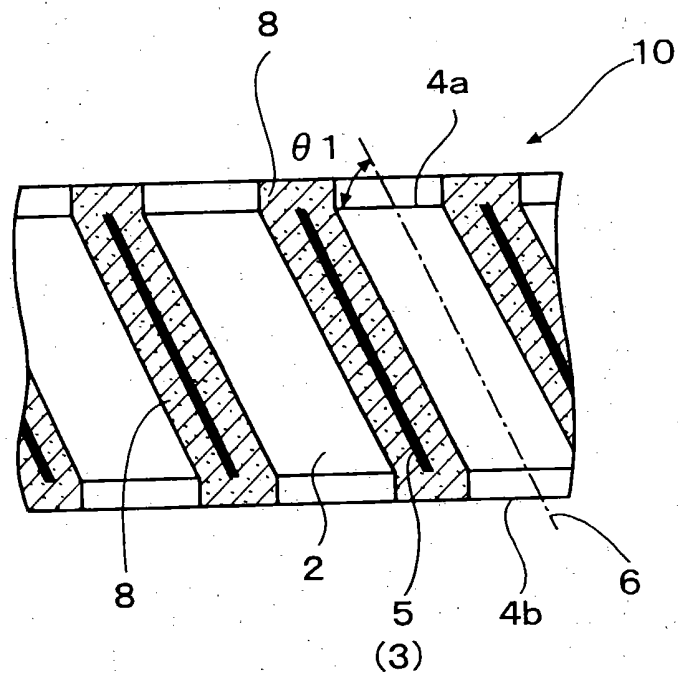


FIG. 12

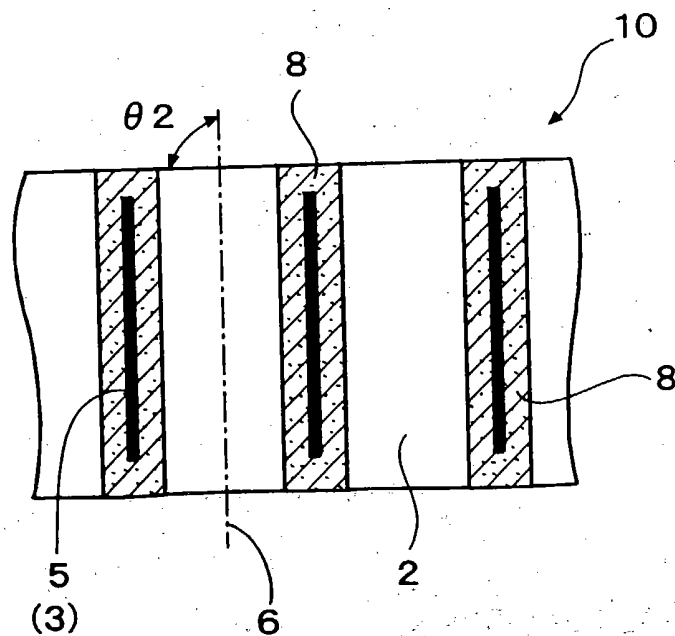


FIG. 13

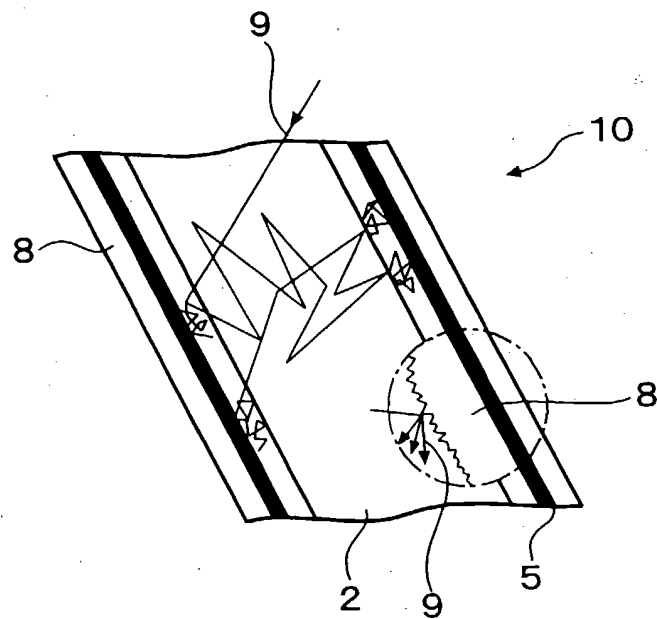


FIG. 14

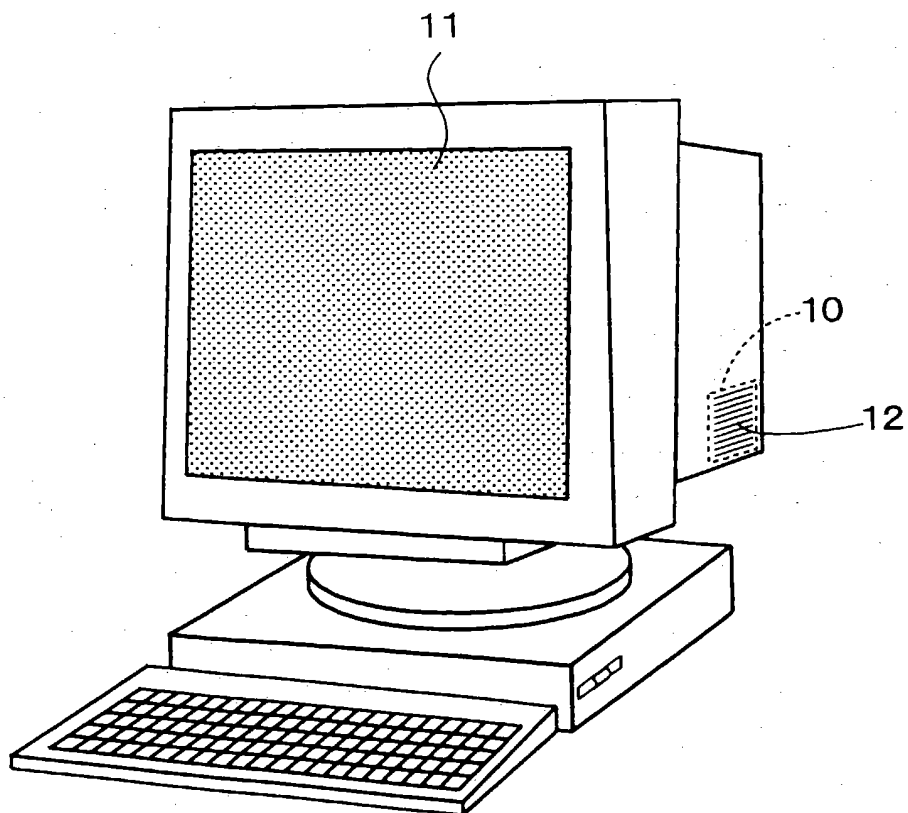


FIG. 15

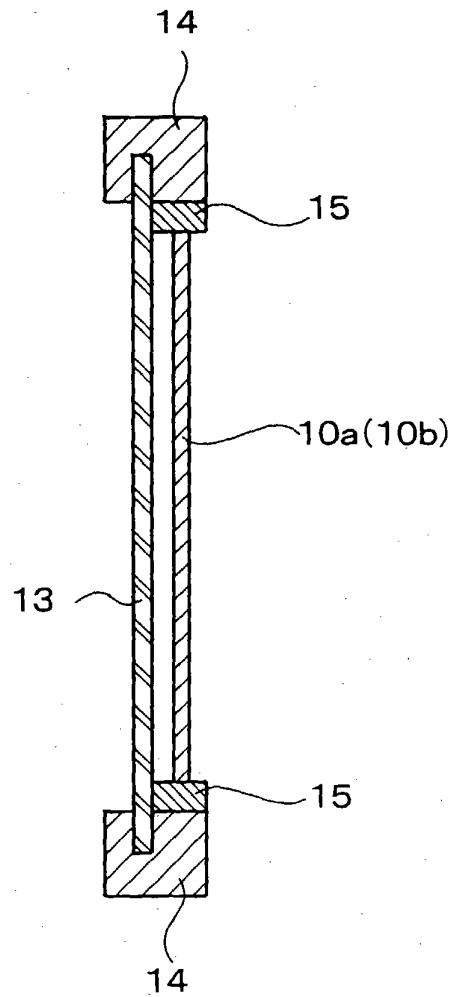


FIG. 16

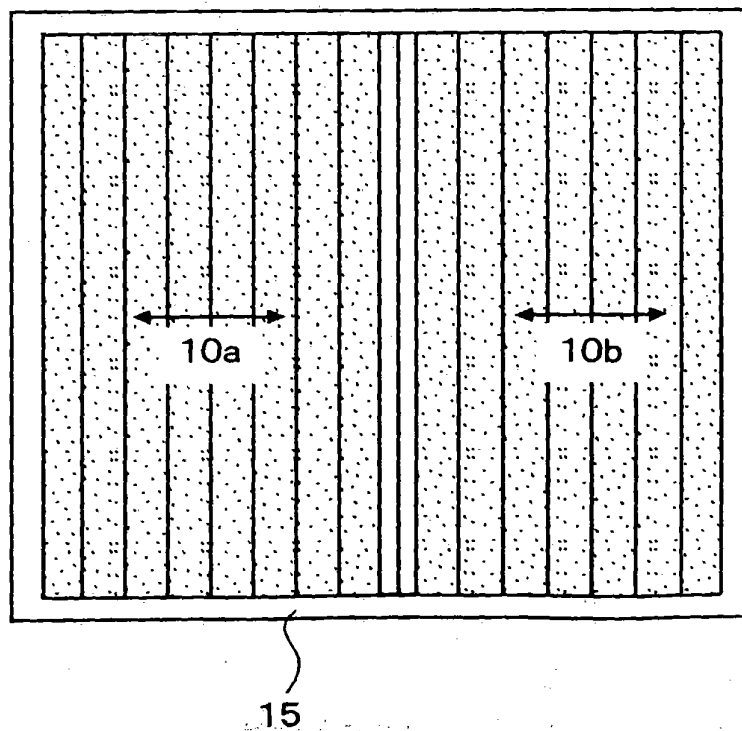


FIG. 17

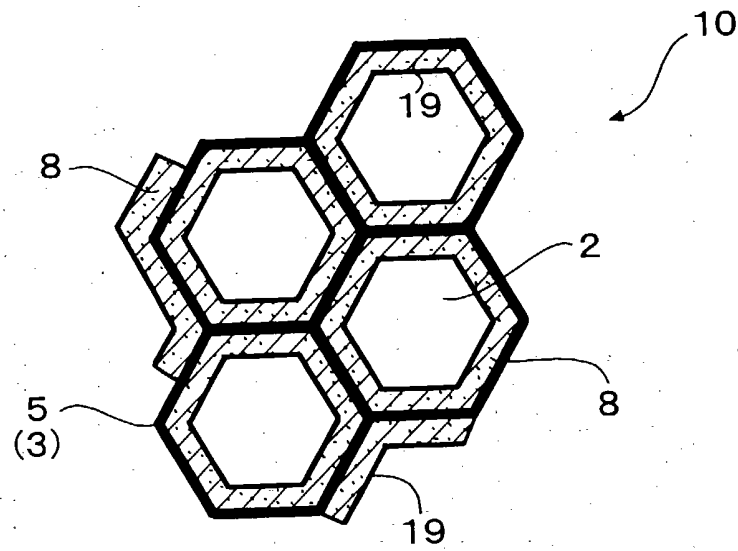


FIG. 18

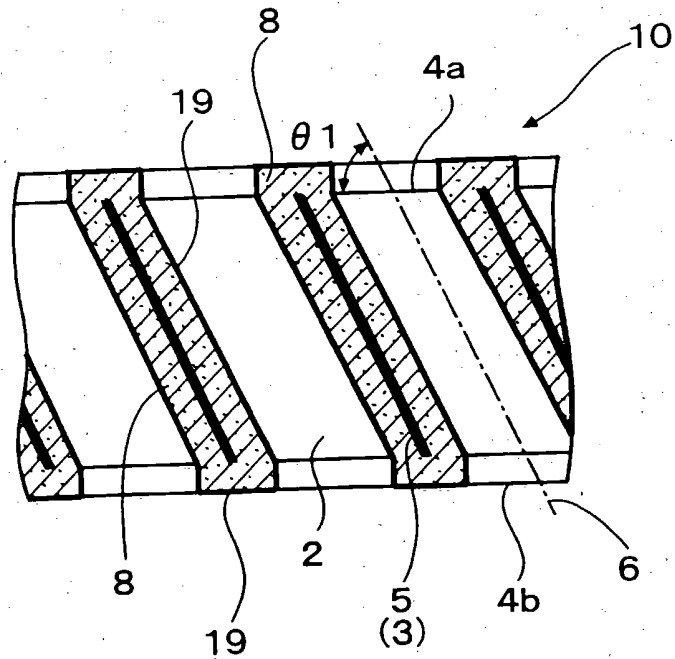


FIG. 19

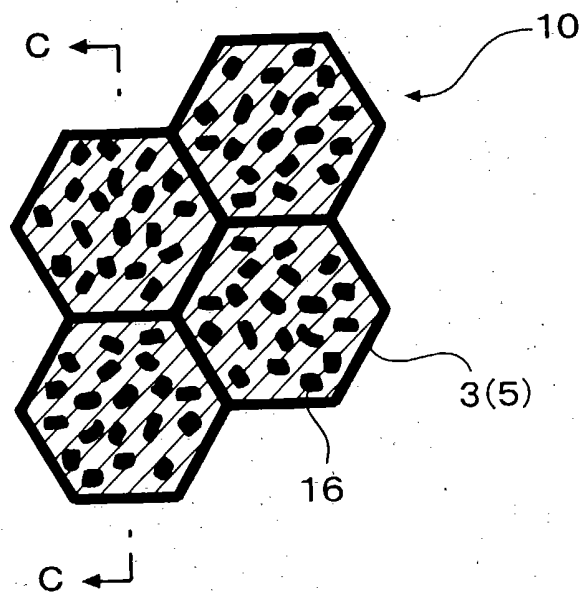


FIG. 20

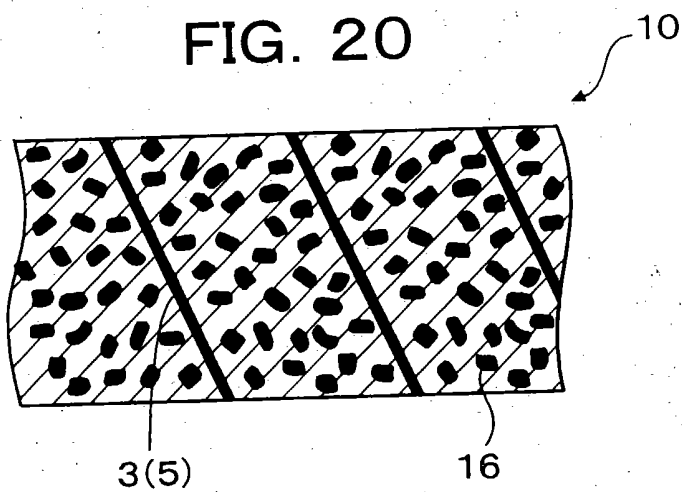


FIG. 21

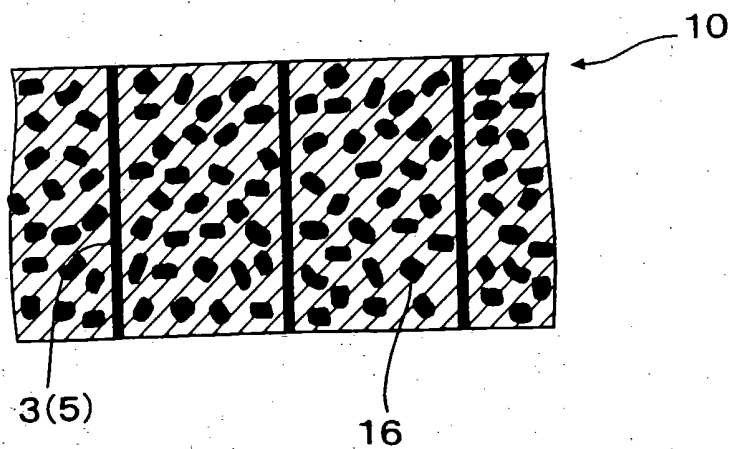


FIG. 22

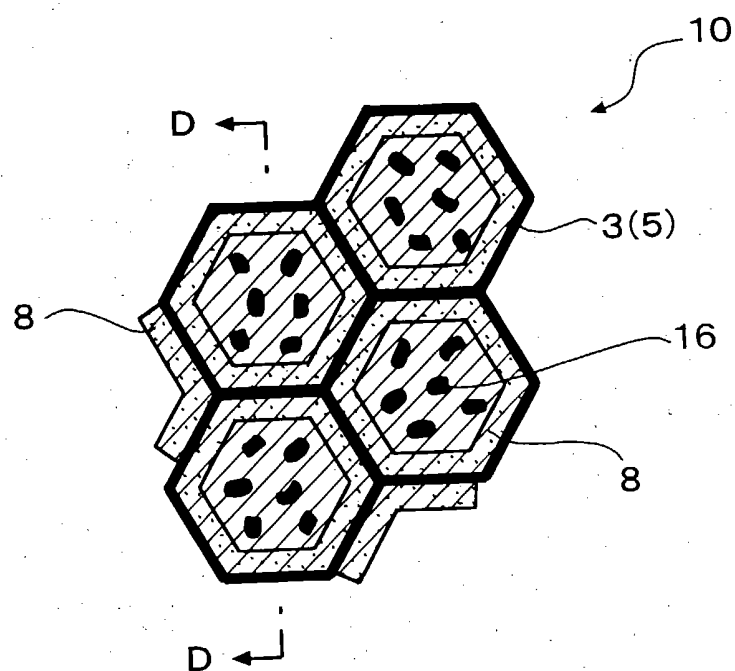


FIG. 23

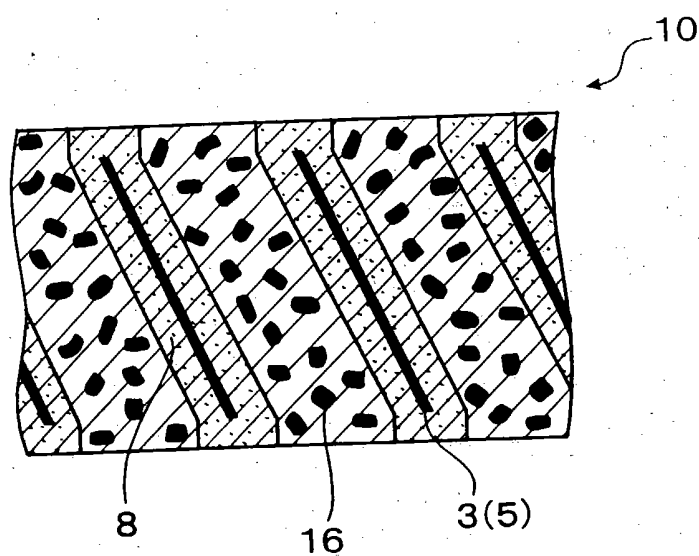


FIG. 24

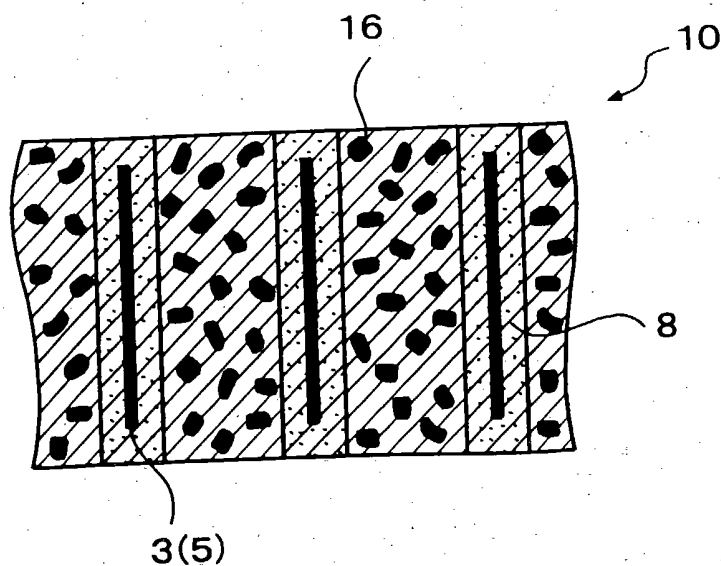


FIG. 25

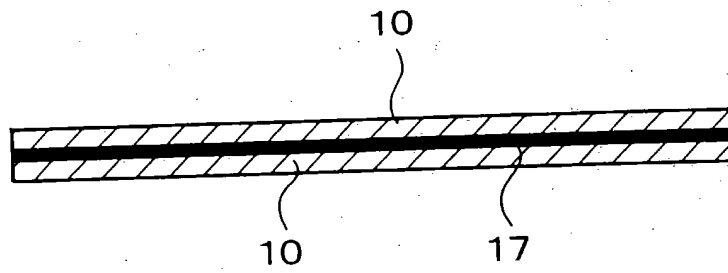


FIG. 26

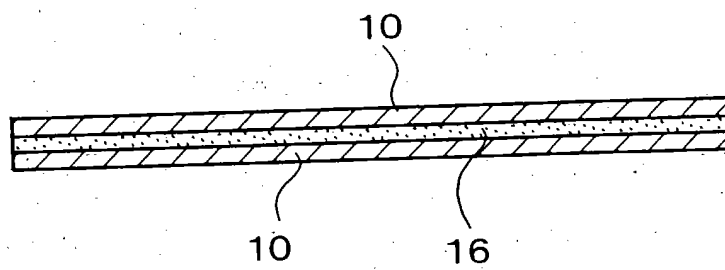


FIG. 27

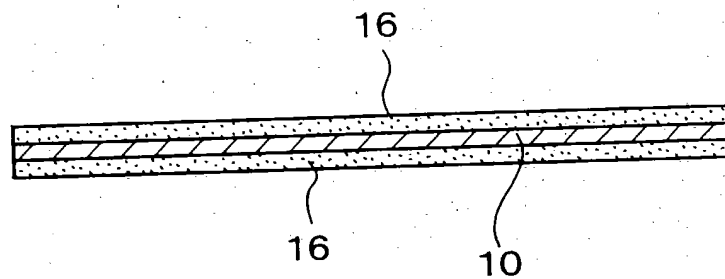


FIG. 28

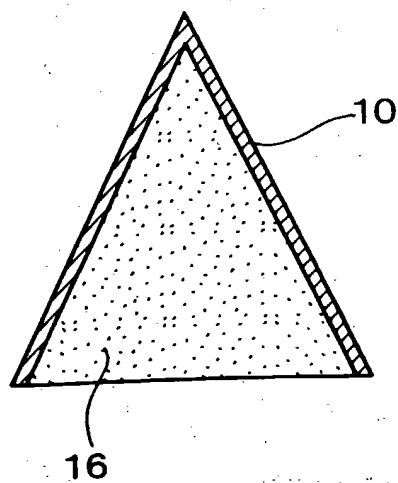


FIG. 29

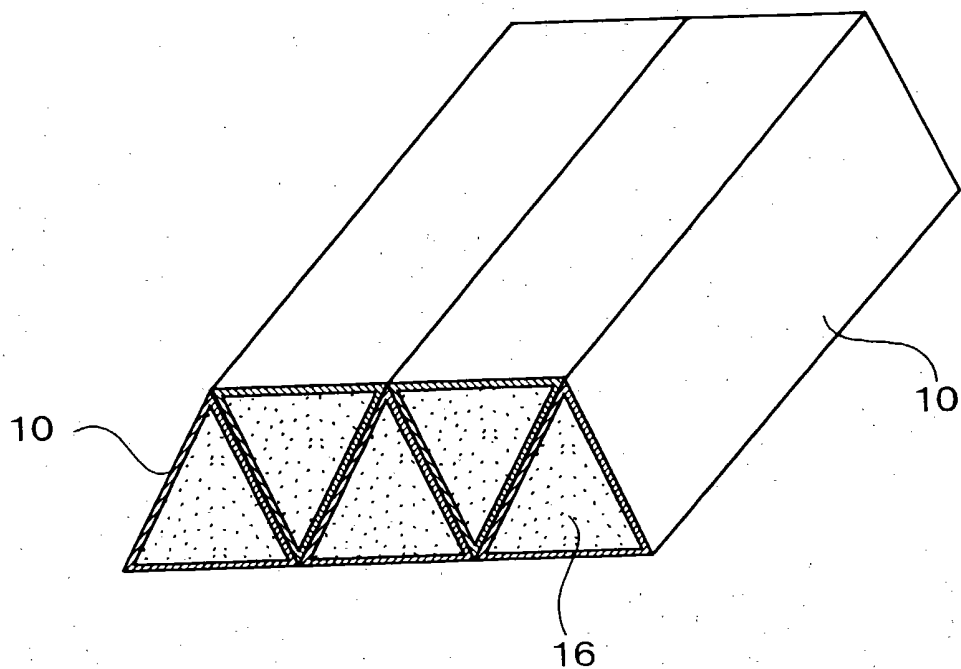


FIG. 30

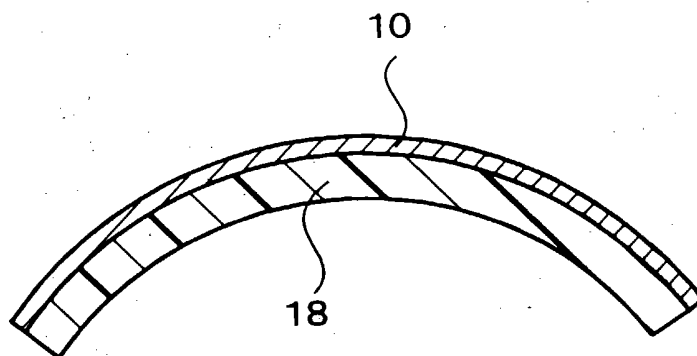


FIG. 31

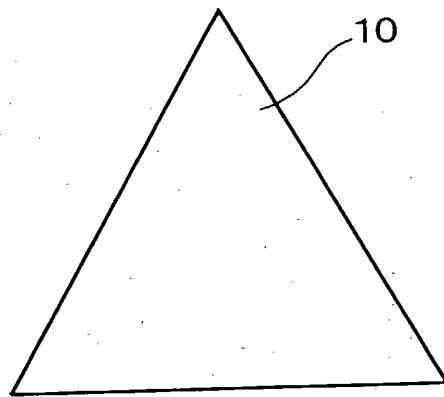


FIG. 32

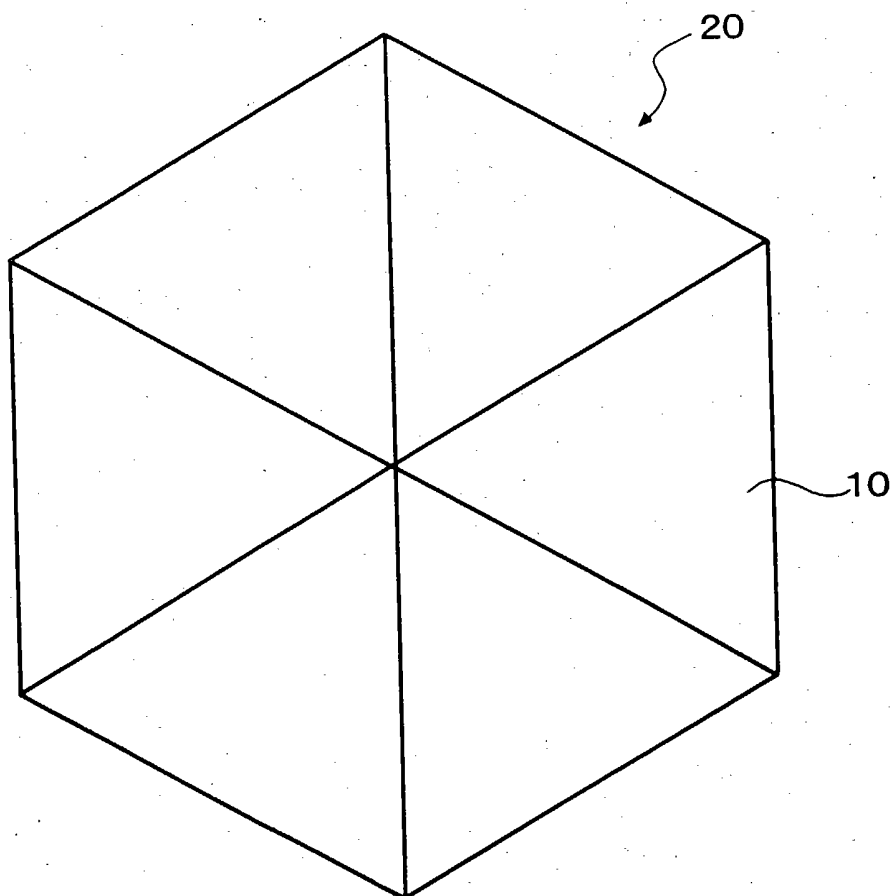


FIG. 33

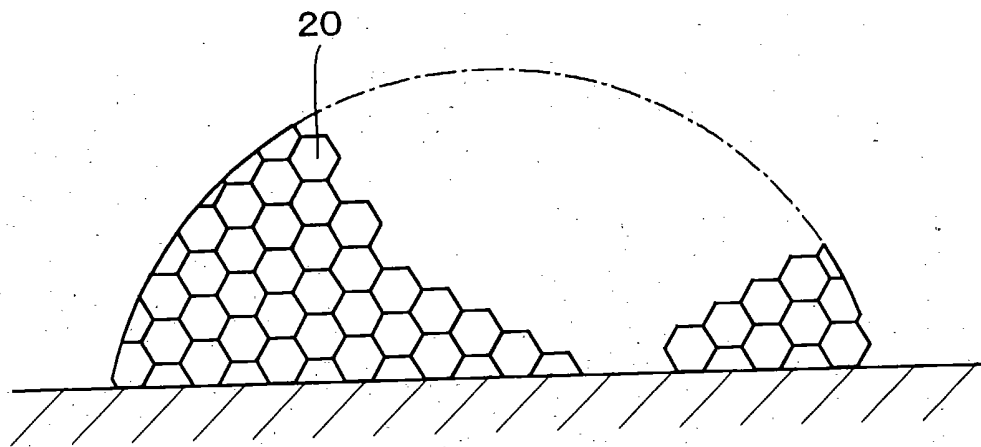


FIG. 34

ELECTRIC FIELD SHIELDING
CHARACTERISTIC (KEC METHOD)

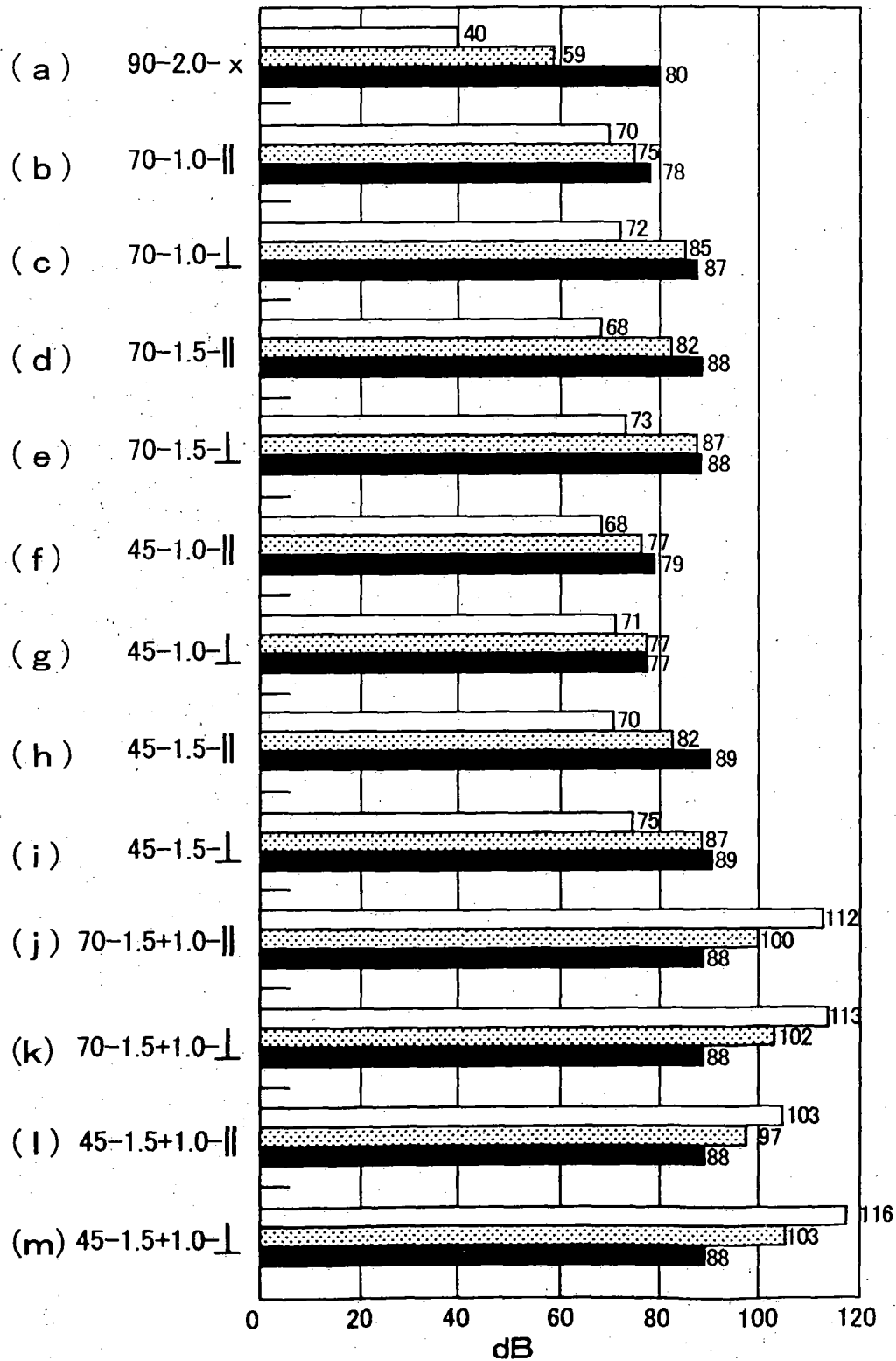
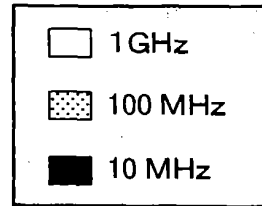


FIG. 35

MAGNETIC FIELD SHIELDING
CHARACTERISTIC (KEC METHOD)

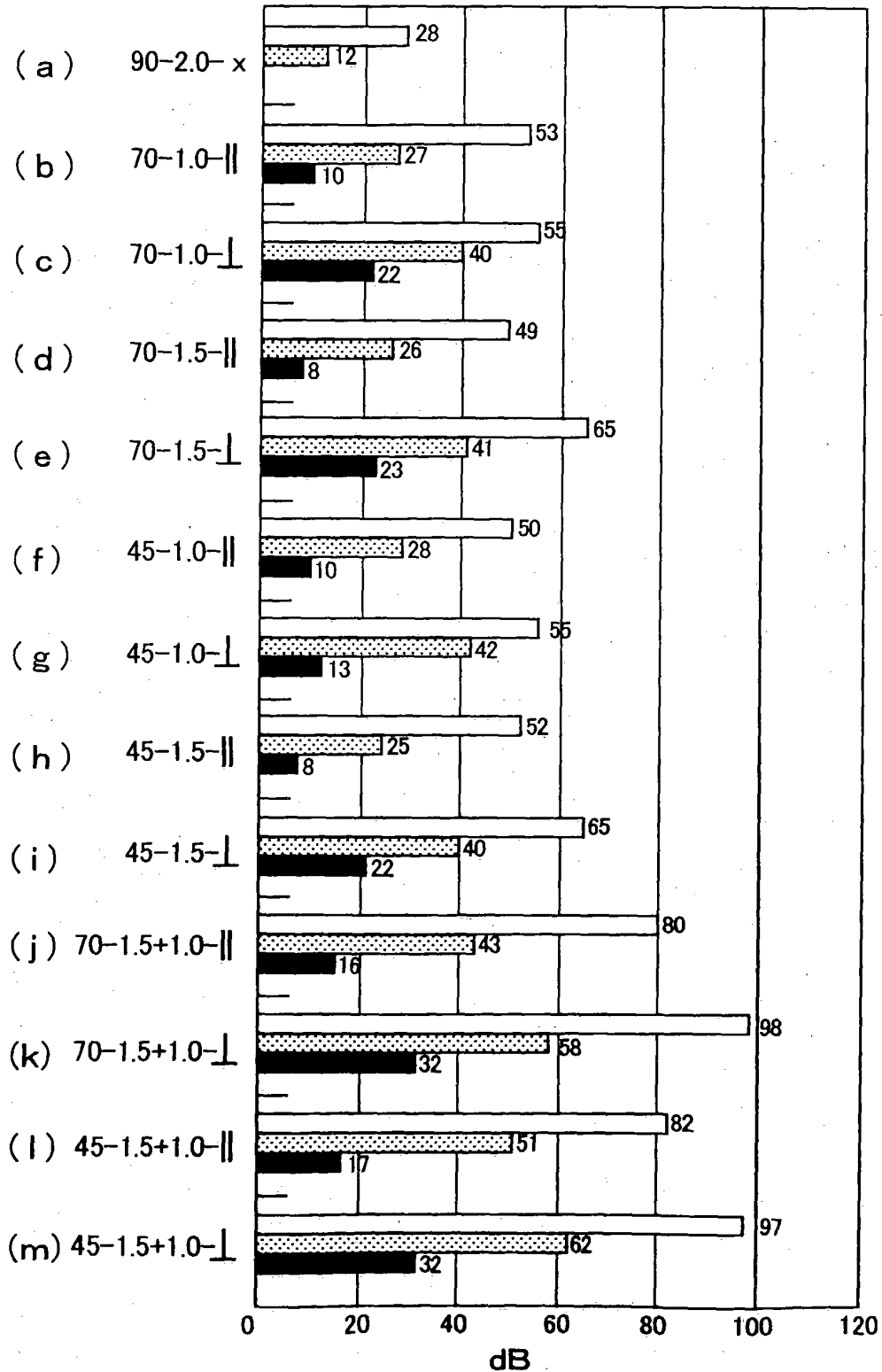
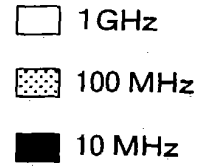


FIG. 36

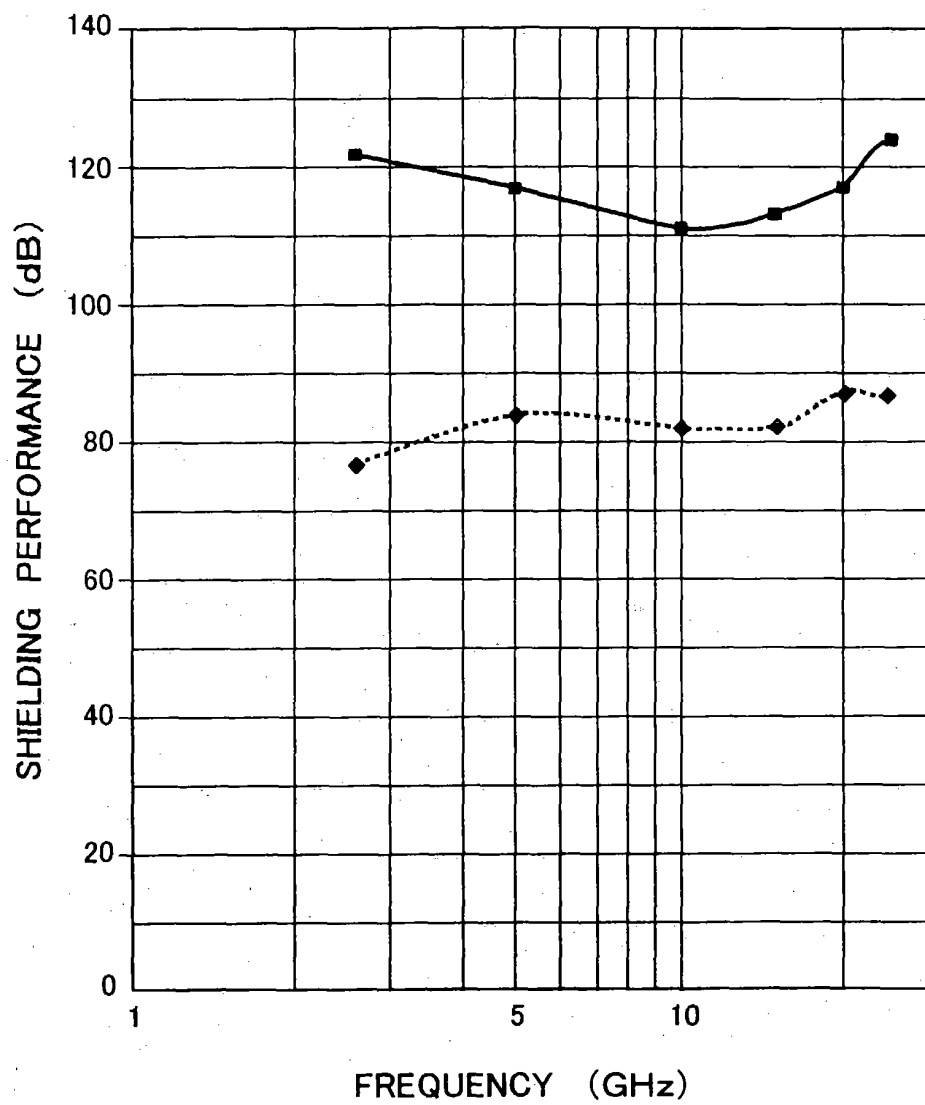


FIG. 37

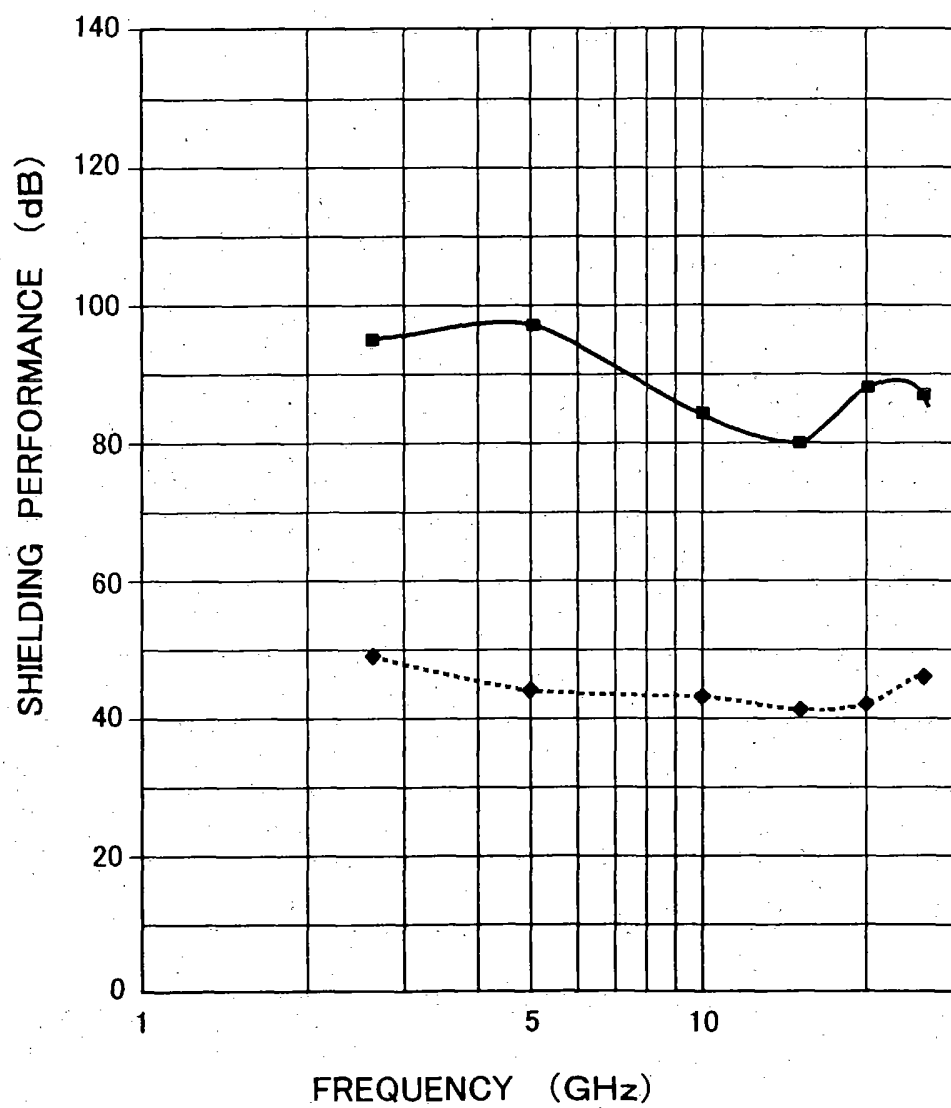


FIG. 38

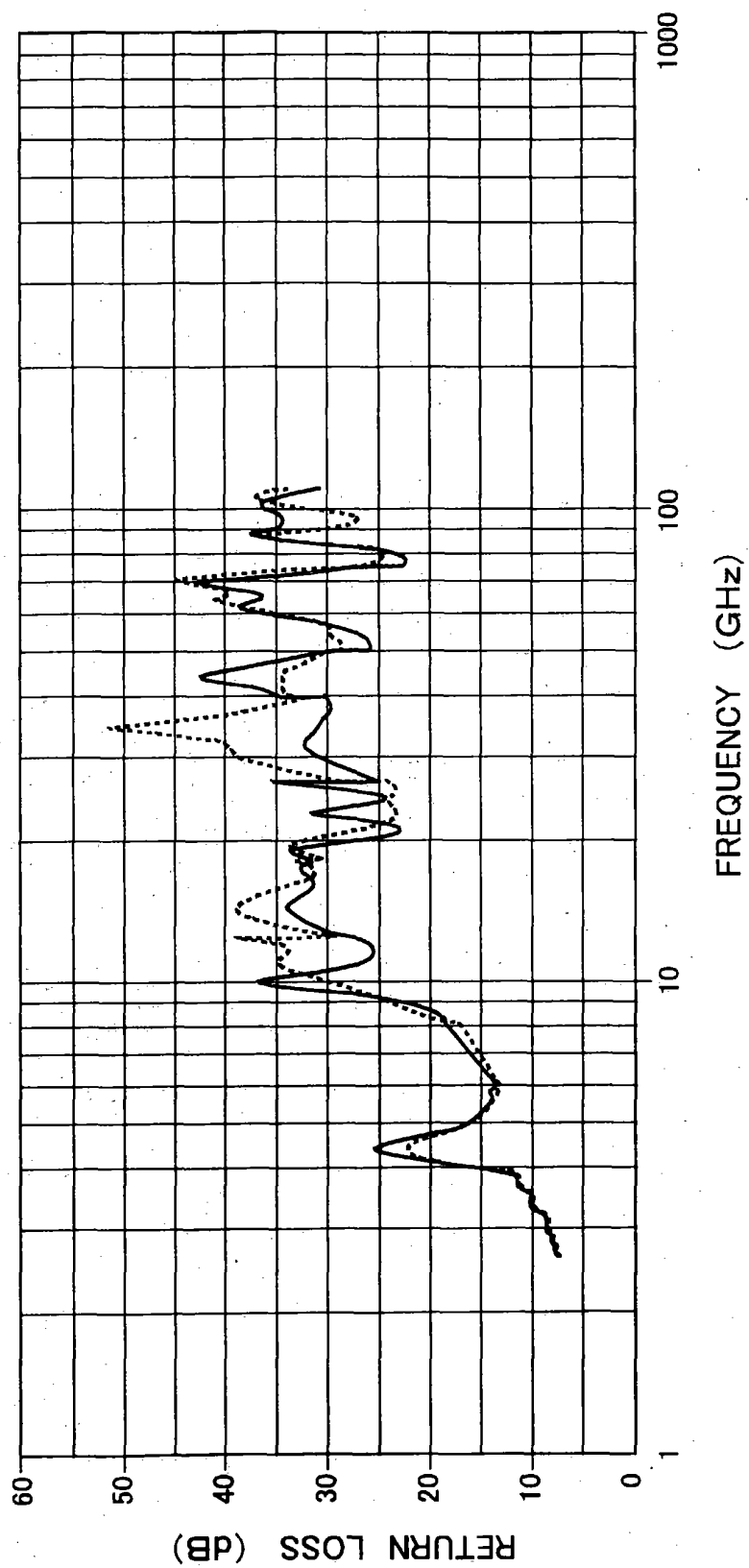


FIG. 39

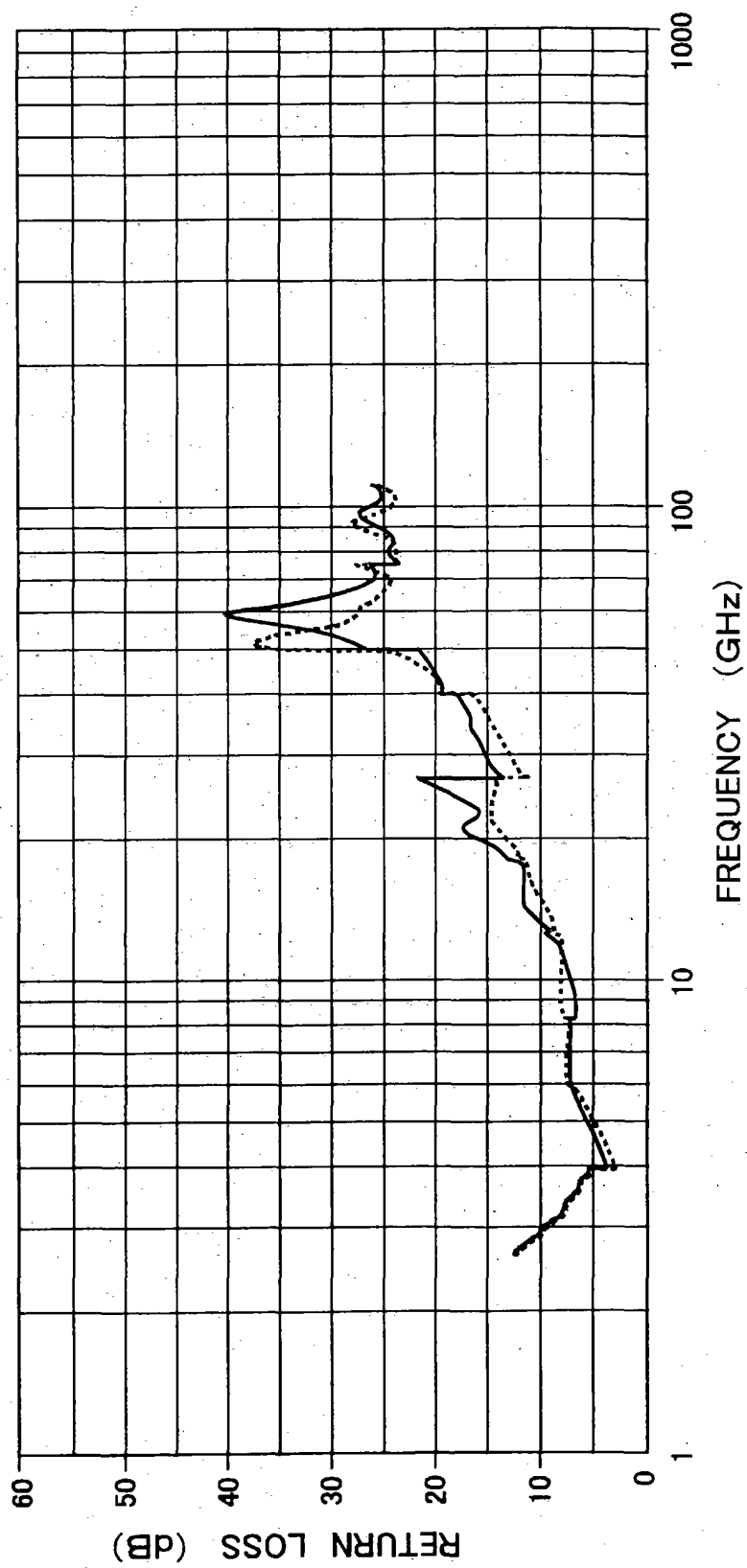


FIG. 40

